Sound Processor Series for FPD TVs



Sound Processor with built-in Surround BD3884FS, BD3886FS

Description

BD3884FS and BD3886FS are pin-compatible and software-compatible sound processors with surround sound and AGC functions. BD3886FS is equipped with a BBE processor, and supports 3 stereo inputs. It is best suited for TV and audio units with 2-channel output, and is capable of presenting high-performance sound.

Features

- 1) BD3886FS is equipped with a BBE processor that can precisely reproduce original sound. It is possible to control the clarity of sound in an optimal way by adjusting the BBE effect.
- 2) The volume difference between input sources is controlled by the AGC circuit.
- 3) Matrix surround that can control diffusion of sound.
- 4) Resistance ladder type circuit is used for volume and tone, realizing low noise (6µVrms) and low distortion (0.008%).
- 5) Reduced shock sound from switching volume or tone.
- 6) By collecting the audio input terminal and audio output terminal respectively, the flow of signals is aligned to one direction. This contributes to facilitate the layout of board pattern, and to reduce the area of the board.

Applications

TV units, such as LCD TV, PDP TV, CATV, DVD, PC, and personal audio.

Product lineup

Function	BD3884FS	BD3886FS
No. of inputs	Stereo 1 input	Stereo 3 input
BBE processor	-	Available
Package	SSOP-A24	SSOP-A32

BD3886FS is an advanced compatible IC with BD3884FS.

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Supply of the set (used by BD3886FS) and sale, are restricted to those to whom the trademark of BBE Sound Inc. and patent use were permitted. For such license of BBE, please contact BBE Sound Inc.

Absolute maximum ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Applied Voltage	VCC	10.0	V
Input Voltage	VIN	VCC+0.3~GND-0.3	V
Dower Dissipation	Dd	BD3884FS :1000 *1	m)//
Power Dissipation	Pa	BD3886FS :1190 *2	TIVV
Operating Temperature	Topr	-40~+85 ^{*3}	°C
Storage Temperature	Tstg	-55~+150	°C

*1 Reduced by 8.0 mW/°C at 25°C or higher. Thermal resistance θja = 125(°C/W).

*2 Reduced by 9.5 mW/°C at 25°C or higher. Thermal resistance θja = 105 (°C/W), when ROHM standard board is mounted. ROHM standard board : Size:70×70×1.6 (mm³)

Material: FR4 glass-epoxy substrate (copper foil area: not more than 3%).

*3 As long as voltage stays within operating voltage range, certain circuit operation is guaranteed in the operating temperature range. Allowable power loss conditions are related to temperature, to which care must be taken. In addition though the standard value of its electrical characteristics cannot be guaranteed under the conditions other than those specified, basic functions are maintained.

Operating range

Parameter	Symbol	Min.	Тур.	Max.	Unit
Power Supply Voltage *4	VCC	7.0	9.0	9.5	V

Basic operation shall be available at Ta = 25°C.

*4 As long as temperature and operating voltage meet specifications

In addition, though the standard value of its electrical characteristics cannot be guaranteed under the conditions other than those specified, basic functions are maintained.

●Electrical characteristics (BD3884FS、BD3886FS)

Unless specified: Ta=25°C, Vcc=9V, f=1kHz, VIN=1Vrms, Rg=600 Ω , RL=10k Ω , INPUT=A1, OUTPUT=OUT1, Volume 0dB, Bass=0dB, Treble=0dB, Surround=OFF, AGC=OFF, BBE=OFF(Only BD3886FS) when corresponding I²C data are sent. The data of 1ch shall be noted, and 2ch shall be of similar characteristics.

	Descrite		Limits			11.5		
	Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	
	Current upon no signal	l _Q	_	8	20	mA	Vin=0Vrms	
	Maximum input voltage	VIM	2.6	2.8	_	Vrms	Front Volume = -6dB THD(Vout)=1% BPF=400-30KHz	
	Maximum output voltage	V _{OM}	2.2	2.5	Ι	Vrms	THD=1% BPF=400-30KHz	
	Voltage gain	Gv	-2	0	2	dB	GV=20log(Vout/Vin)	
	Channel balance	СВ	-1.5	0	1.5	dB	CB = GV1-GV2	
Ţ	Total harmonic distortion	THD	_	0.008	0.1	%	Vout=500mVrms BPF=400-30KHz	
ER	Output noise voltage *	V _{NO}	—	6	18	μVrms	BPF = IHF-A, Rg=0Ω	
GEN	Residual noise voltage *	V _{MNO}	_	1.5	10	μ Vrms	Front Volume = -87dB Rear Volume = $-\infty$ dB BPF = IHF-A, Rg=0 Ω	
	Cross talk *	СТ	70	80	_	dB	CT = 20log(Vin/Vout) BPF = IHF-A	
	Input impedance	Rina	70	100	130	kΩ	BD3884FS : IN1(11pin), IN2(12pin) BD3886FS : A1(13pin), A2(14pin)	
	Input impedance (B,C) (only BD3886FS)	R _{INBC}	52	75	98	kΩ	B1(15pin), C1(18pin) B2(16pin), C2(17pin)	

	Dominister		Limits					
	Parameter	Symbol	Min.	Тур.	Max.	Unit	Conditions	
. ш	Control range	V _{ATIF1}	-90	-87	-84	dB	V _{ATT} =20log(Vout/Vin)、BPF = IHF-A	
	Switching step	SVFC	-	1	-	dB		
<u>ò</u> FR	Set error 1	Evfc1	-2	0	2	dB	0dB to -63dB	
	Set error 2	E _{VFC2}	-3	0	3	dB	-64dB to -87dB	
	Control range	VATTR	-	-100	-90	dB	V _{ATT} =20log(Vout/Vin)、BPF = IHF-A	
	Switching step1	S _{VRC1}	-	2	-	dB	0dB to -20dB	
	Switching step 2	S _{VRC2}	-	5	-	dB	-20dB to -30dB	
AR JME	Switching step 3	S _{VRC3}	-	15	-	dB	-30dB to -60dB	
OLL OLL	Set error 1	E _{VRC1}	-2	0	2	dB	0dB to -30dB	
>	Set error 2	E _{VRC2}	-3	0	3	dB	-45dB , -60dB	
	Max. Attenuation	ATTMAX	_	-110	-90	dB	Front Volume = -87 dB Rear Volume = $-\infty$ BPF = IHF-A	
	Boost control range	V _{BBMAX}	+11	+14	+17	dB	f=80Hz、Vin=100mVrms Bass = +14dB VBBMAx=20log(Vout/Vin)	
BASS	Cut control range	V _{BCMAX1}	-17	-14	-11	dB	f=80Hz、Vin=100mVrms Bass = -14dB VBCMAX=20log(Vout/Vin)	
	Control step	S _{BC}	-	2	-	dB		
	Set error 1	E _{BS1}	-2	0	2	dB	f=80Hz、0dB~8dB	
	Set error 2	E _{BS2}	-3	0	3	dB	f =80Hz、10dB~14dB	
	Boost control range	V _{TBMAX1}	+11	+14	+17	dB	f=15kHz、Vin=100mVrms Treble = +14dB VTBMAX=20log(Vout/Vin)	
REBLE	Cut control range	V _{TCMAX1}	-17	-14	-11	dB	f=15kHz、Vin=100mVrms Treble = -14dB VTCMAX=20log(Vout/Vin)	
	Control step	STC	-	2	-	dB		
	Set error 1	E _{TS1}	-2	0	2	dB	f=15Hz、0dB~8dB	
	Set error 2	E _{TS2}	-3	0	3	dB	f =15Hz、10dB~14dB	
	AGC I/O level 1	AGC1	0.7	1.0	1.4	mVrms	Vin=1.0mVrms ¹⁾	
о С	AGC I/O level 2	AGC2	70	100	130	mVrms	Vin=50mVrms ¹⁾	
AC	AGC I/O level 3	AGC3	150	200	250	mVrms	Vin=200mVrms ¹⁾	
	AGC I/O level 4	AGC4	150	220	300	mVrms	Vin=1.0Vrms ¹⁾	
3E ^{33886FS)}	Contour control range	V _{BBCMAX}	+8	+10	+12	dB	f=50Hz、Vin=100mVrms BBE Contour = +10dB VBBCMAX=20log(Vout/Vin)	
BI (Only BC	Process control range	VBBCMAX	+8	+10	+12	dB	f=10kHz、Vin=100mVrms BBE Process = +10dB VBBPMAx=20log(Vout/Vin)	
	Surround common mode gain	V _{sur1}	-2	0	2	dB	Vin=100mVrms	
Ð	Surround single mode gain	V _{sur2}	4.3	6.3	8.3	dB	Vin=100mVrms ch contacts AC	
ROUN SEL .INE	Surround reverse mode gain	V _{sur3}	8	10	12	dB	Vin=100mVrms ch : reverse mode	
SUF	SEL output gain LINE OUT output gain	V _{SEL}	-3	-1	+1	dB		
	SEL output gain LINE OUT output gain	V _{LINE}	-2	0	2	dB		

* VP-9690A (Average value detection, effective value display) IHF-A filter by Matsushita Communication is used for * measurement.

* Phase of I/O signal terminals is the same phase.

* This IC is not designed to be radiation-resistant.

* 1): 1ch/2ch simultaneous input, AGC level = 200 mVrms

Timing chart

Electric specifications and timing of bus line and I/O stages



Fig.-1 Timing definition on I²C BUS

Table 1: Characteristics of SDA of I²C BUS and SCL bus line

	Parameter	Symbol	Standar I ² C	Unit	
			Min.	Max.	
1	SCL clock frequency	f _{SCL}	0	100	kHz
2	Bus free time between a STOP and START condition	t _{BUF}	4.7	_	μs
3	Hold time (repeated) START condition. After this period, the first clock pulse is generated	t _{HD;STA}	4.0	_	μs
4	LOW period of the SCL clock	t _{LOW}	4.7	—	μs
5	HIGH period of the SCL clock	t _{HIGH}	4.0	—	μs
6	Set-up time for a repeated START condition	t _{SU;STA}	4.7	_	μs
7	Data hold time	t _{HD;DAT}	0*	_	μs
8	Data set-up time	$t_{\text{SU; DAT}}$	250	—	ns
9	Rise time of both SDA and SCL signals	t _R	—	1000	ns
10	Fall time of both SDA and SCL signals	t _F	_	300	ns
11	Set-up time for STOP condition	tsu;sто	4.0	_	μs
12	Capacitive load for each bus line	Cb	_	400	pF

All the above values correspond to ViHmin and VILmax level. (See Table 2)

* Since the transmitter exceeds the un-defined area of SCL trail end, it is necessary to provide the internal hold time of minimum 300ns for SDA signal (SCL signal V_{IH min}.).

Table 2: Characteristics of I²C bus SDA and SCL I/O stage

	Parameter	Symbol	Standaı I ² C	Unit	
		-	Min.	Max.	
13	Low-level input voltage: fixed input levels	VIL	-0.5	1.5	V
14	Low-level input voltage: fixed input levels	VIH	3.0	—	V
15	Hysteresis of Schmitt trigger inputs: fixed input levels	V _{hys}	n/a	n/a	V
16	Pulse width of spikes which must be suppressed by the input filter.	t _{SP}	n/a	n/a	ns
17	Low-level output voltage (open drain): at 3mA sink current	V _{OL1}	0	0.4	V
18	Output fall time from VIHmin. to VIHmax. with a bus capacitance from 10 pF to 400pF: with up to 3mA sink current at VOL1	t _{OF}		250	ns
19	Input current each I/O pin with an input voltage between 0.4V and 0.9 VDDmax.	li	-10	10	μA
20	Capacitance for each I/O pin	Ci	_	10	pF

n/a = Not applicable

Data format

(BD3884FS)

	Select	MSB			da	ta			LSB
Set item	Address (HEX)	D7	D6	D5	D4	D3	D2	D1	D0
Front Volume	00H	*	Front Volume						
Rear Volume	01H		Rear Volume 1ch				Rear Volume 2ch		
Bass/Treble	02H		Bass Gain				Treble Gain		
AGC Level	03H		*					AGC Sup Le	pression vel
Input Selector	04H		*					Input Selector	
Mute/Surround/ AGC	05H		*				AGC ON/OFF	Surround ON/OFF	MUTE ON/OFF

(BD3886FS)

	Select	MSB	MSB data						LSB	
Set item	Address (HEX)	D7	D6	D5	D4	D3	D2	D1	D0	
Front Volume	00H	*	Front Volume							
Rear Volume	01H		Rear Volume 1ch					Rear Volume 2ch		
Bass/Treble	02H		Bass	Gain		Treble Gain				
AGC Level/ BBE	03H		BBE Contour			BBE Proces	S	AGC Sup Le	pression vel	
Input Selector	04H		*					Input Selector		
Mute/Surround/ AGC/BBE	05H		:	*		BBE ON/OFF	AGC ON/OFF	Surround ON/OFF	MUTE ON/OFF	

*: Don't care

Operation Notes

- 1. Numbers and data in entries are representative design values and are not guaranteed values of the items.
- 2. Although ROHM is confident that the example application circuit reflects the best possible recommendations, be sure to verify circuit characteristics for your particular application. Modification of constants for other externally connected circuits may cause variations in both static and transient characteristics for external components as well as this Rohm IC. Allow for sufficient margins when determining circuit constants.
- 3. Absolute maximum ratings

Use of the IC in excess of absolute maximum ratings, such as the applied voltage or operating temperature range (Topr), may result in IC damage. Assumptions should not be made regarding the state of the IC (short mode or open mode) when such damage is suffered. A physical safety measure, such as a fuse, should be implemented when using the IC at times where the absolute maximum ratings may be exceeded.

4. GND potential

Ensure a minimum GND pin potential in all operating conditions. Make sure that no pins are at a voltage below the GND at any time, regardless of whether it is a transient signal or not.

5. Thermal design

Perform thermal design, in which there are adequate margins, by taking into account the permissible dissipation (Pd) in actual states of use.

6. Short circuit between terminals and erroneous mounting

Pay attention to the assembly direction of the ICs. Wrong mounting direction or shorts between terminals, GND, or other components on the circuits, can damage the IC.

7. Operation in strong electromagnetic field

Using the ICs in a strong electromagnetic field can cause operation malfunction.







Fig.3 Application circuit diagram (BD3886FS)

Reference data









Fig.15 Soft switching wave



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